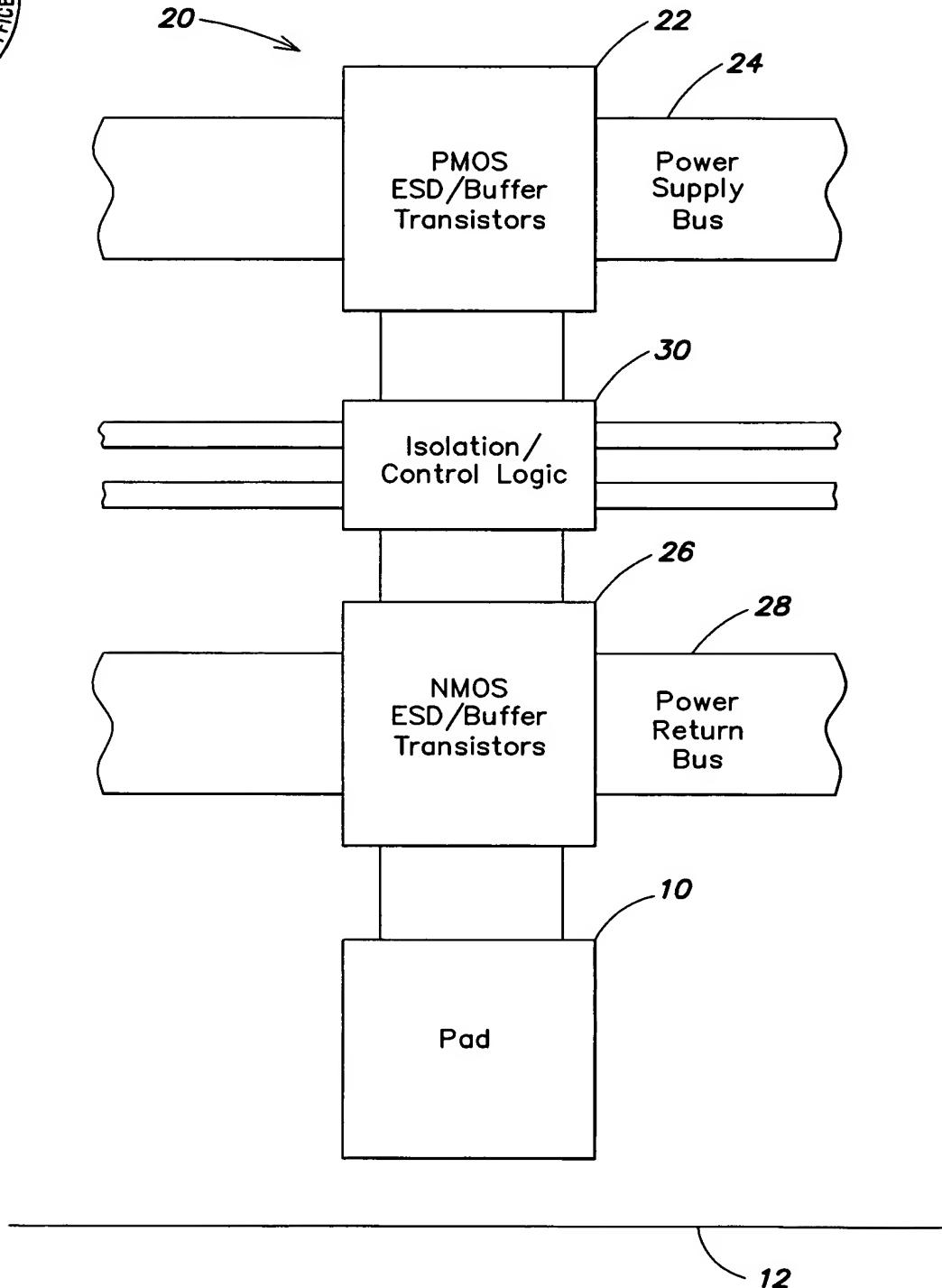
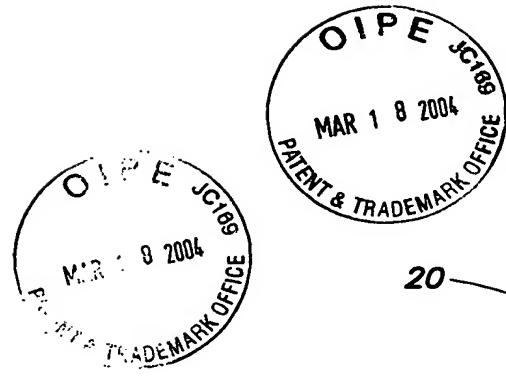
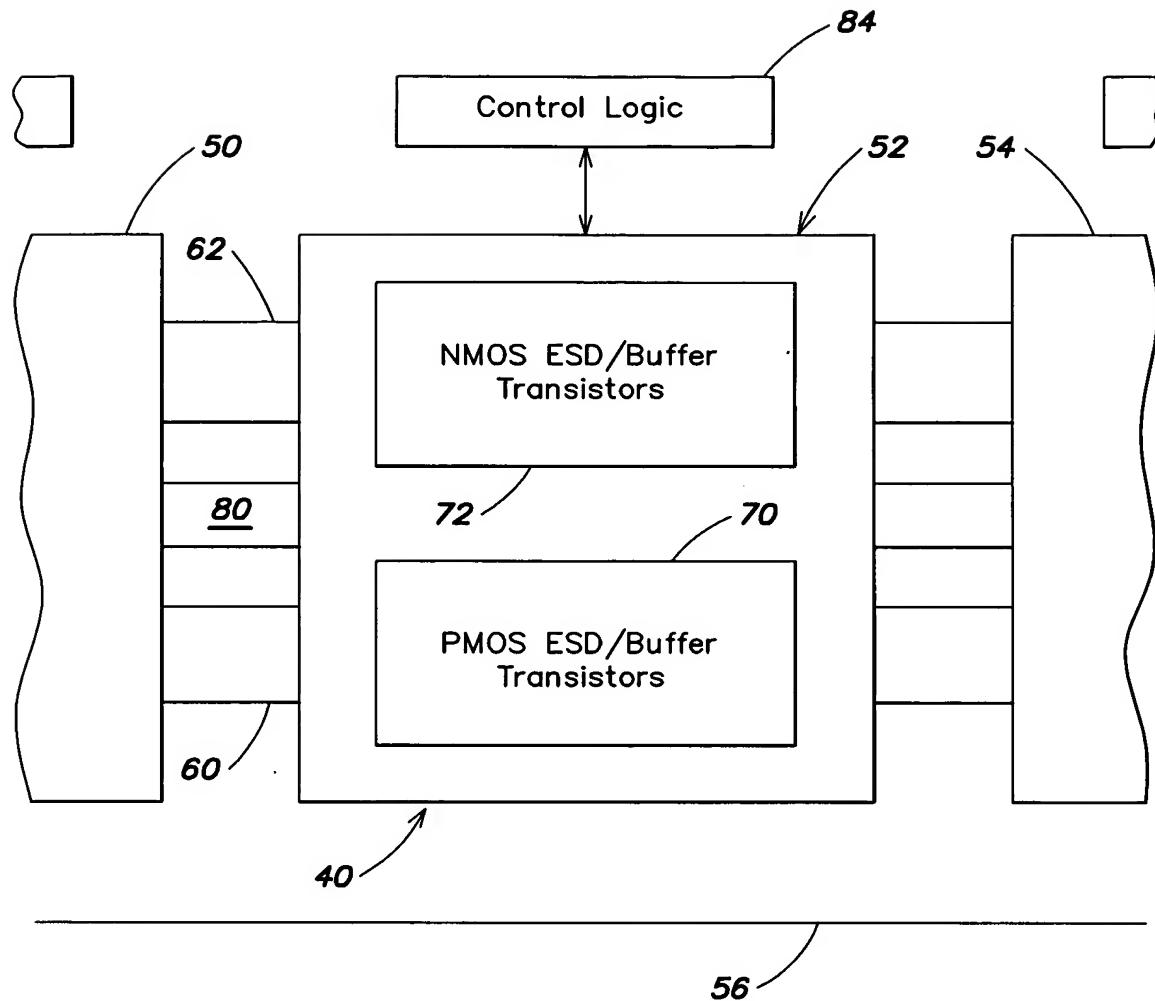


Integrated Circuit Bond Pad Structures  
and Methods of Making  
Alan W. Righter  
Serial No.: 10/694,675



**FIG. 1**  
(Prior Art)



**FIG. 2**

Integrated Circuit Bond Pad Structures  
and Methods of Making  
Alan W. Righter  
Serial No.: 10/694,675

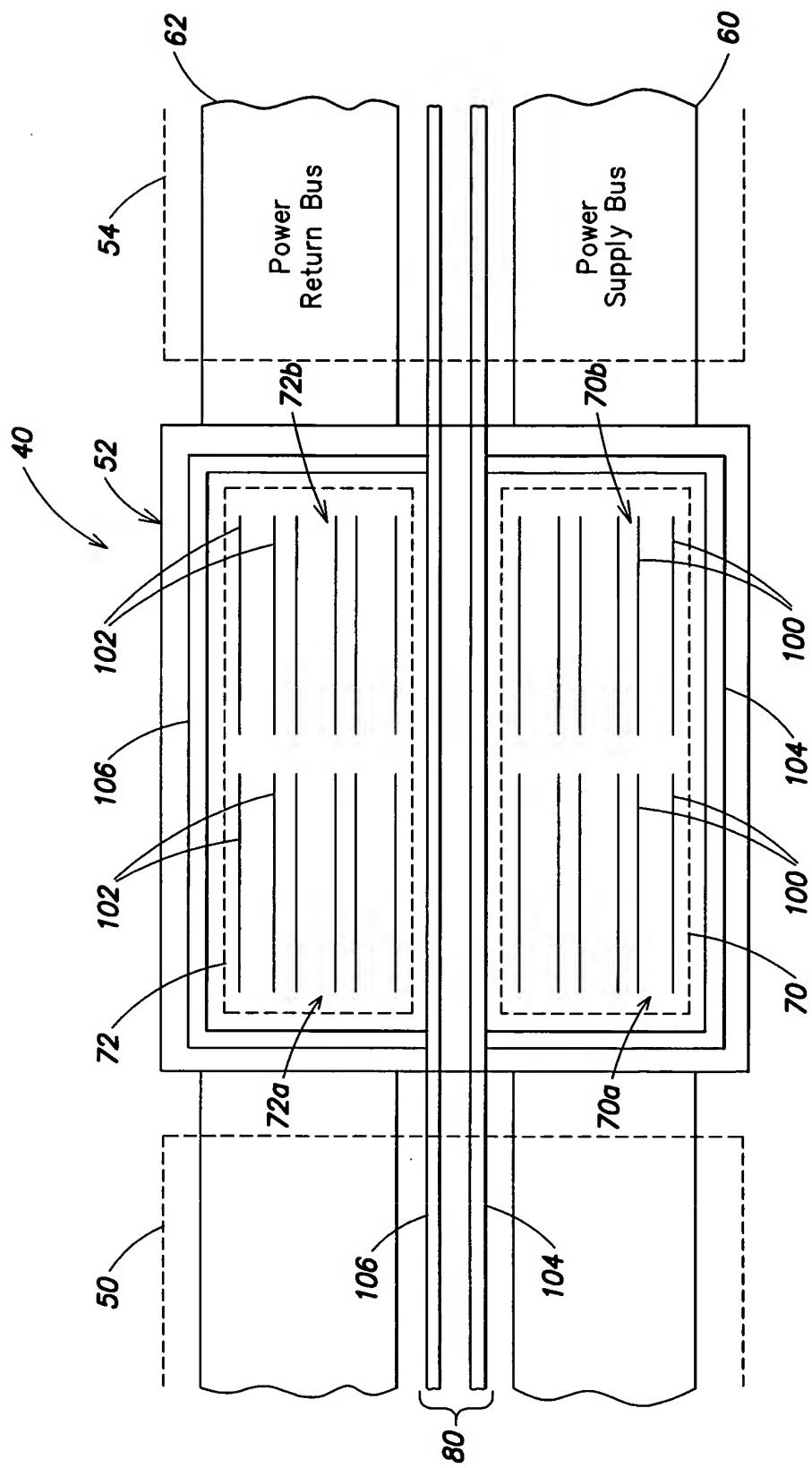


FIG. 3

Integrated Circuit Bond Pad Structures  
and Methods of Making  
Alan W. Righter  
Serial No.: 10/694,675

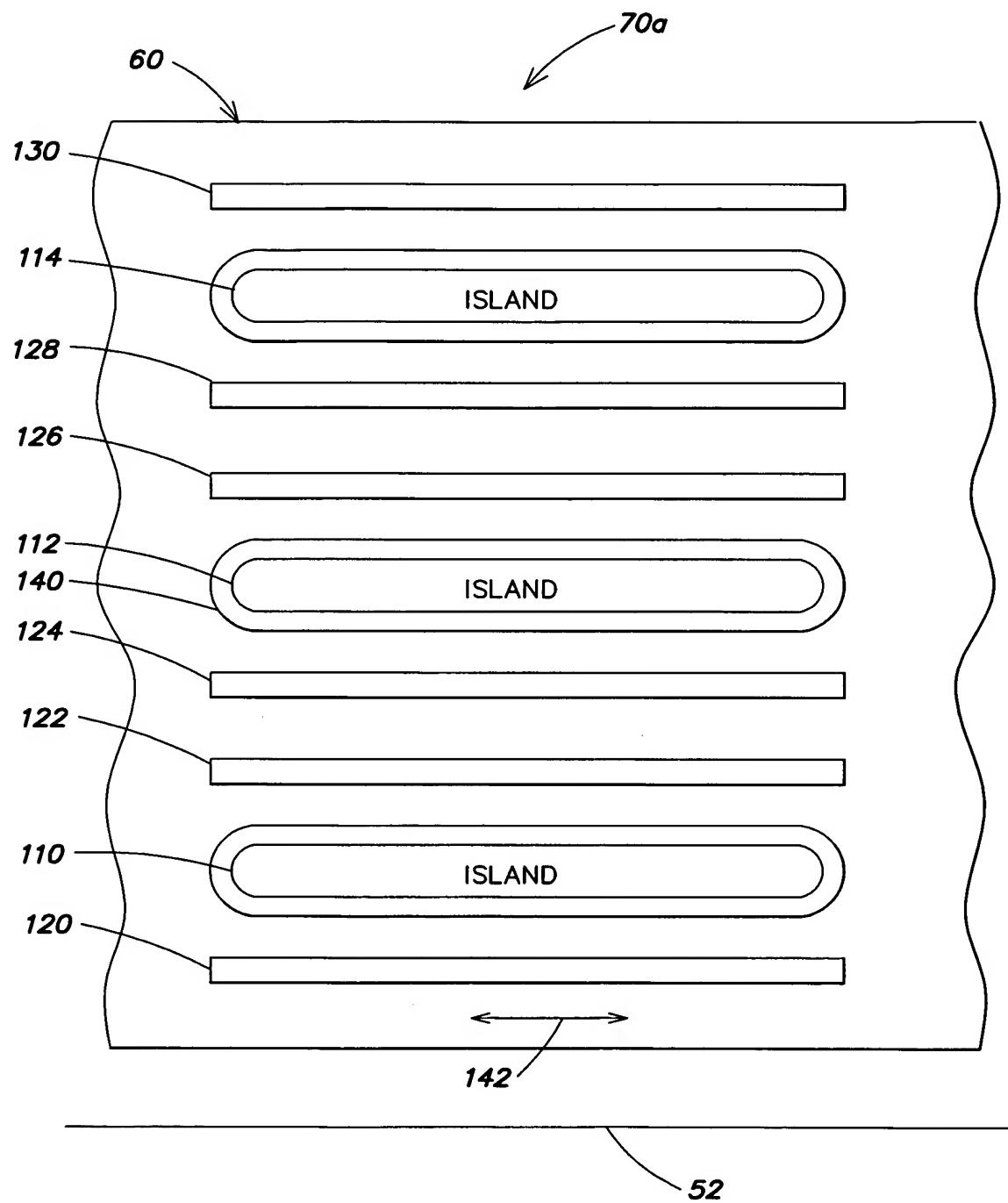


FIG. 4

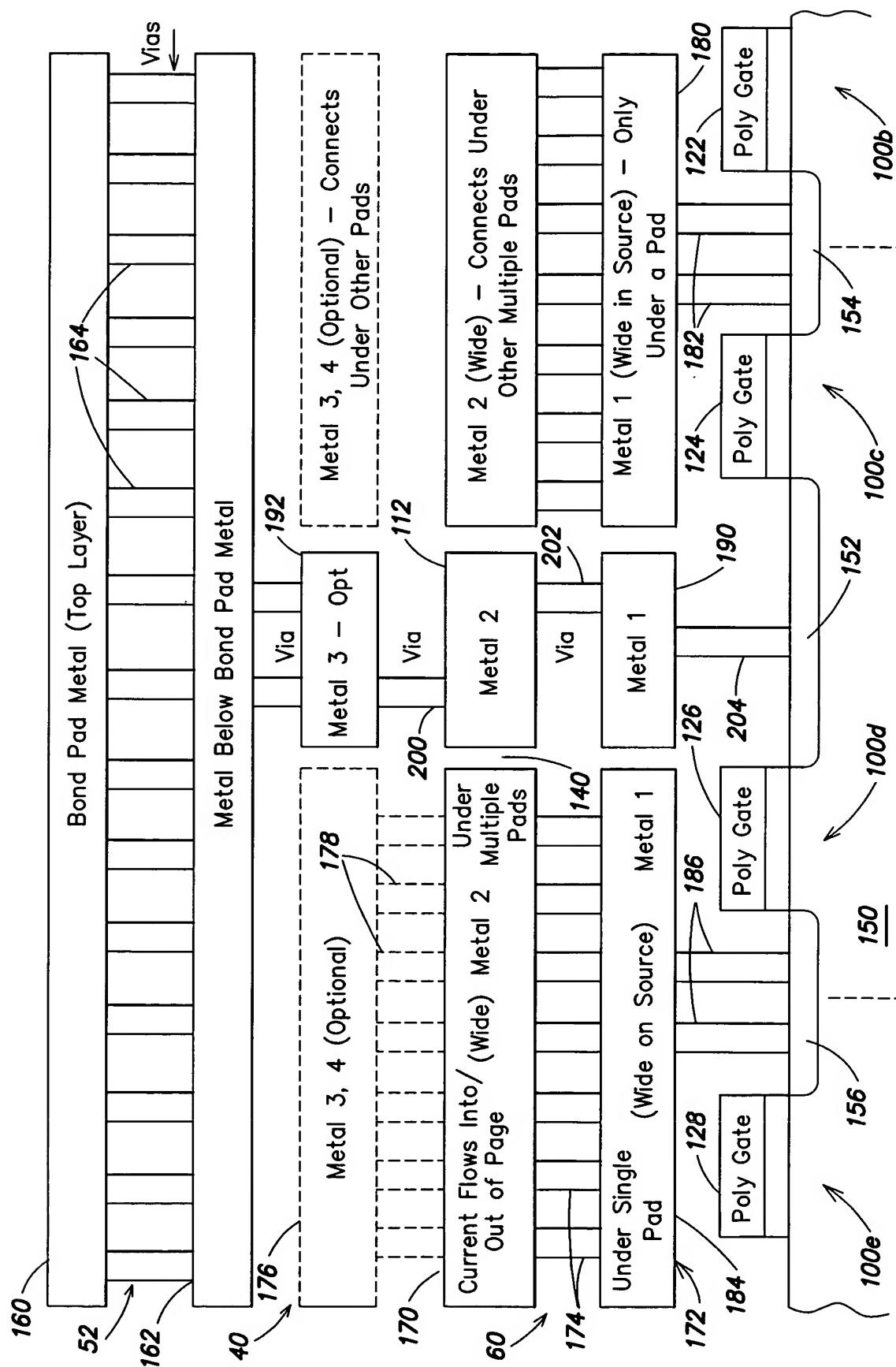


FIG. 5

Integrated Circuit Bond Pad Structures  
and Methods of Making  
Alan W. Righter  
Serial No.: 10/694,675

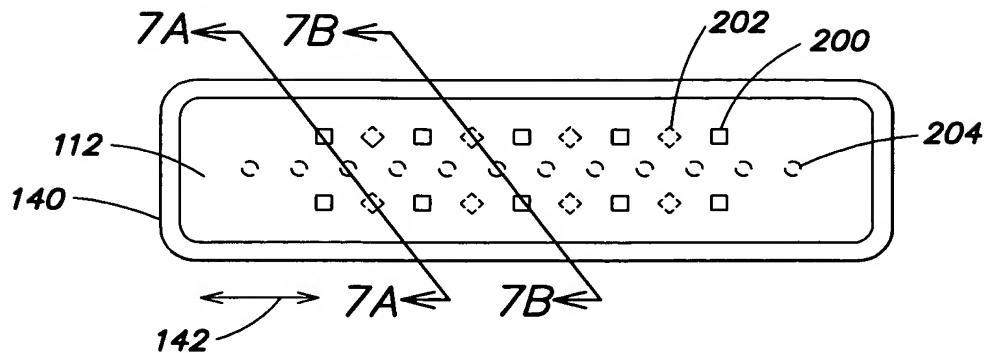


FIG. 6

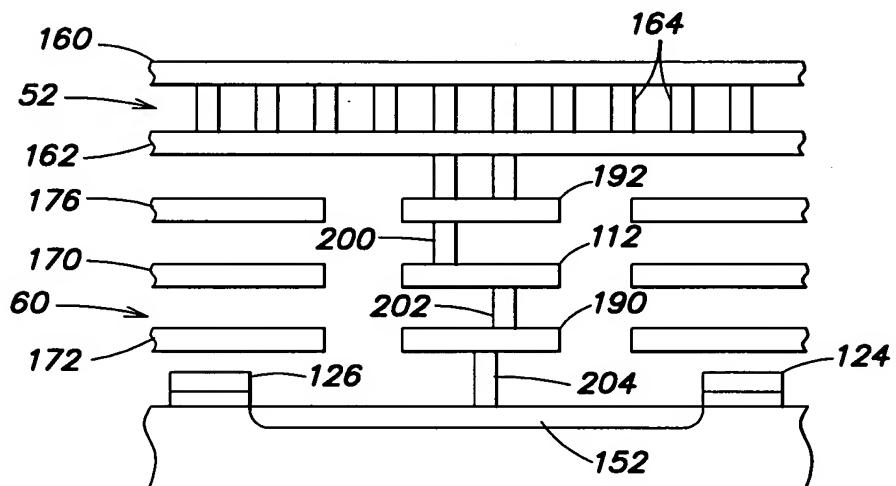


FIG. 7A

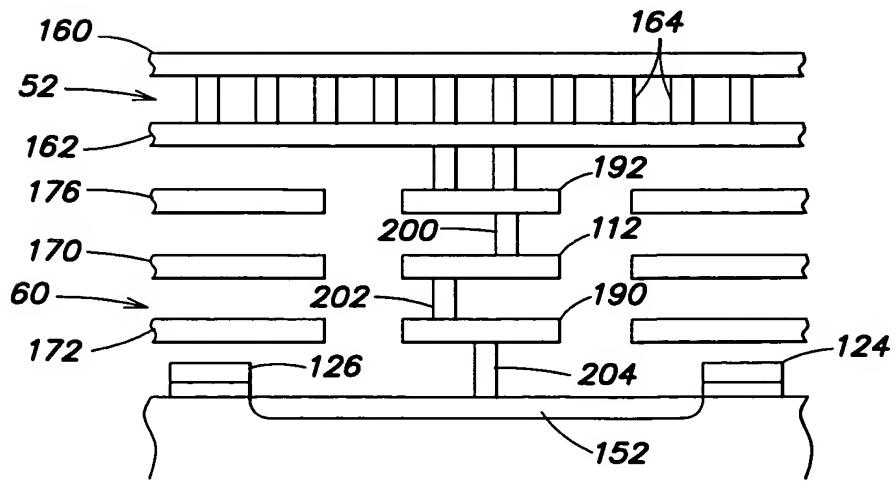


FIG. 7B

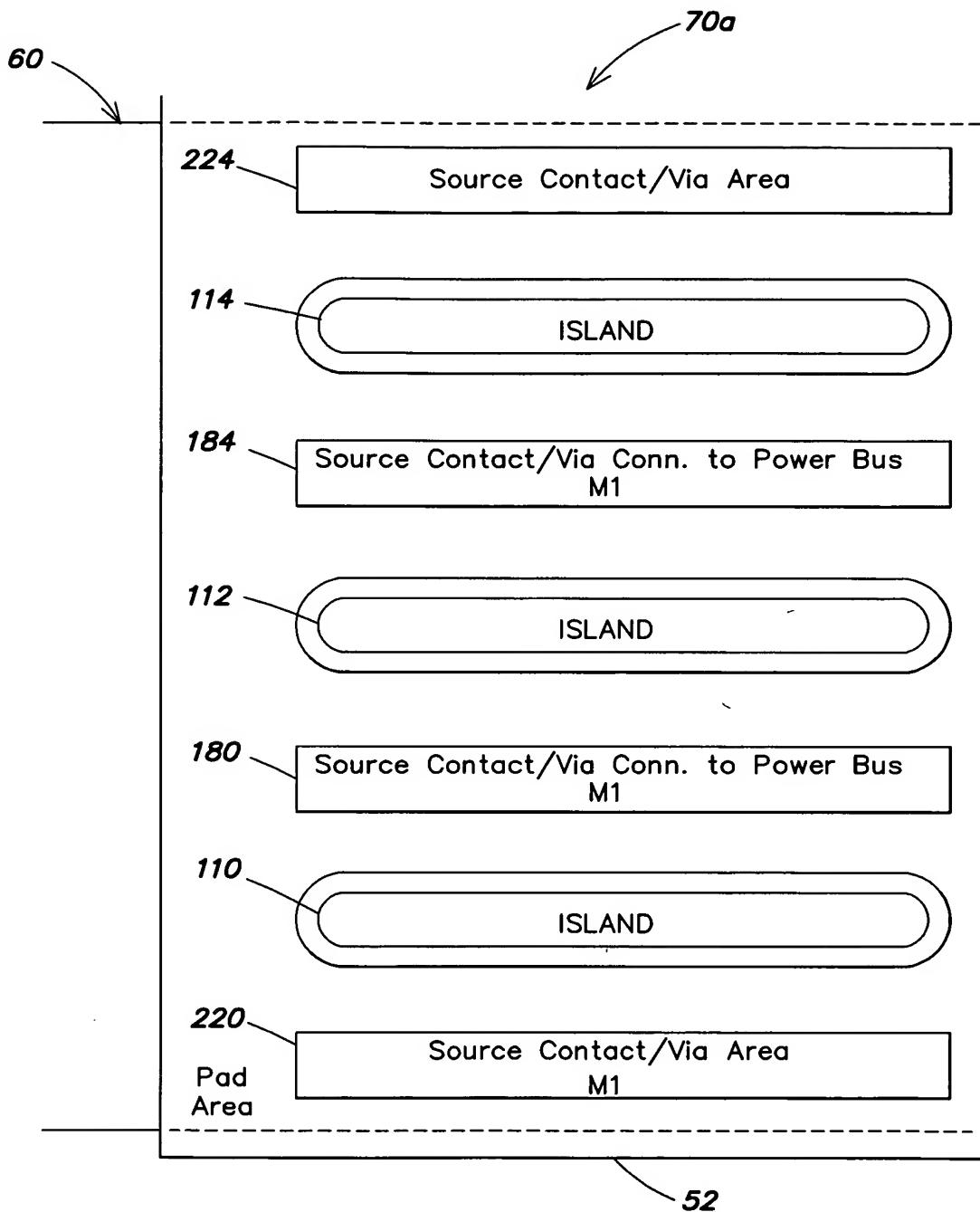
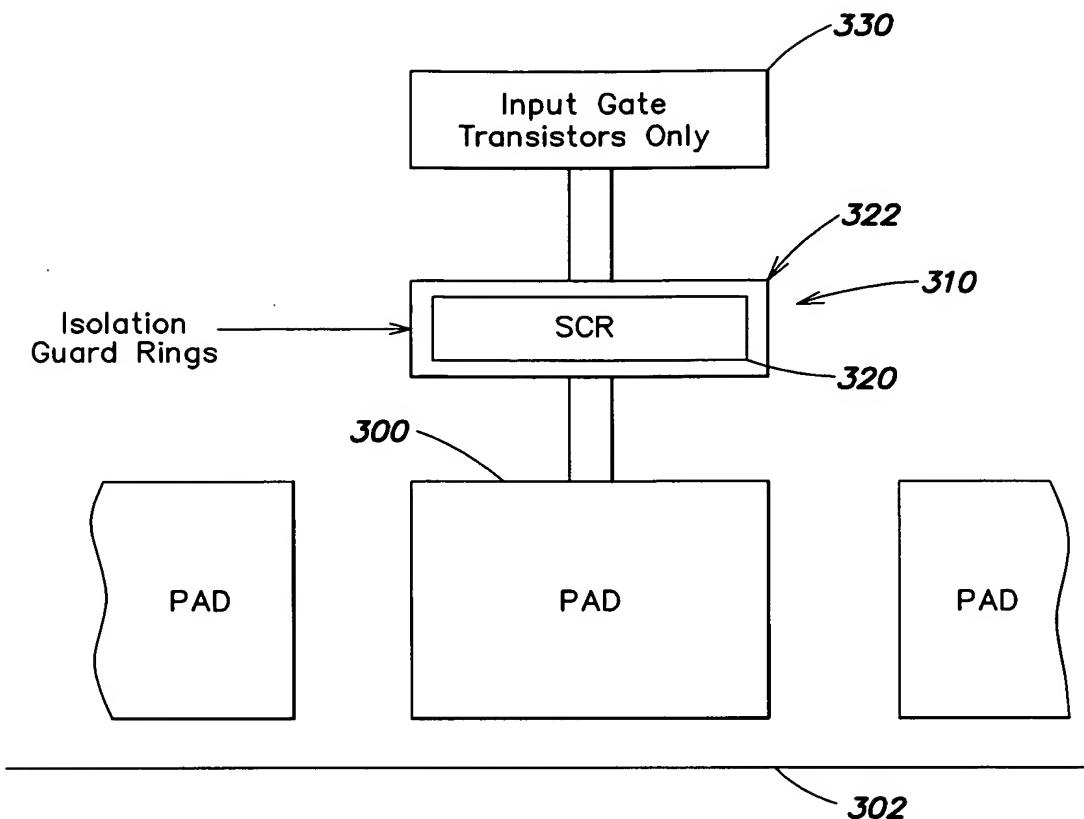


FIG. 8



**FIG. 9**  
(Prior Art)

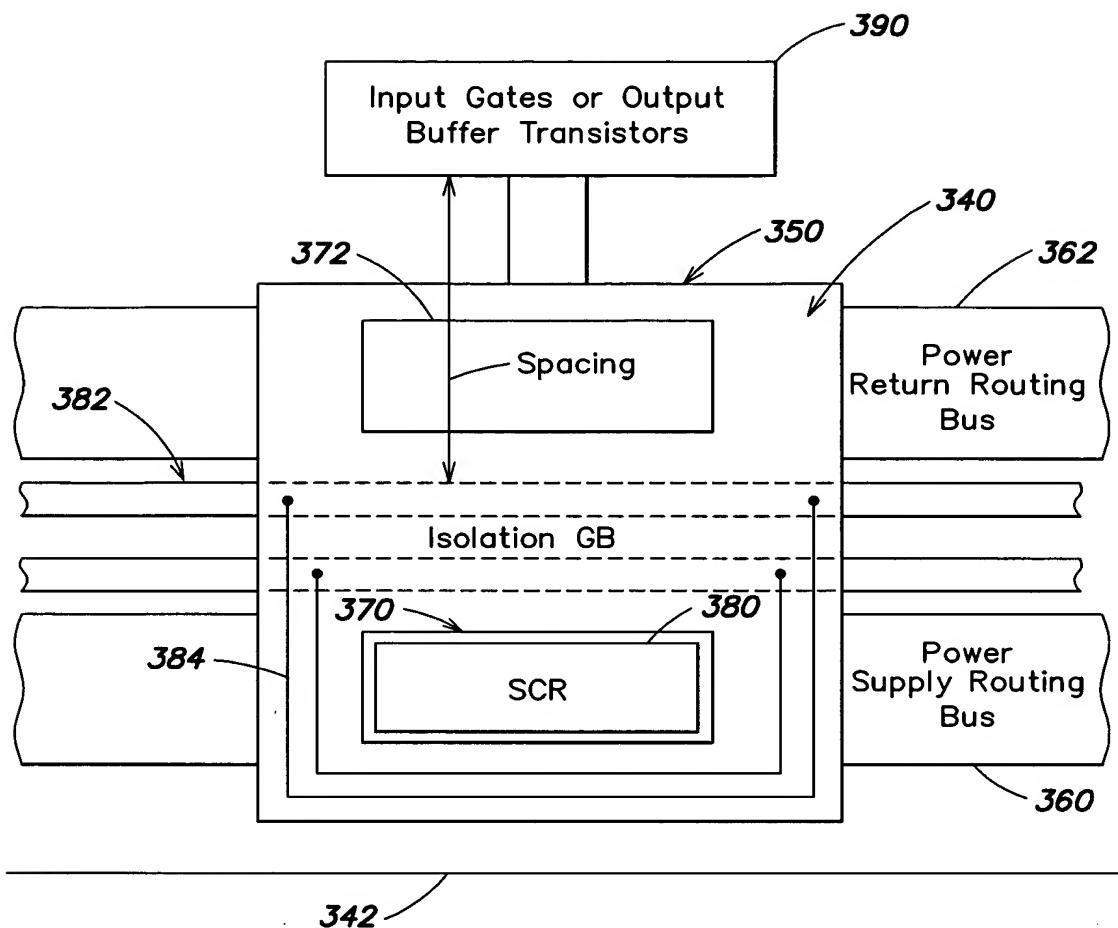


FIG. 10

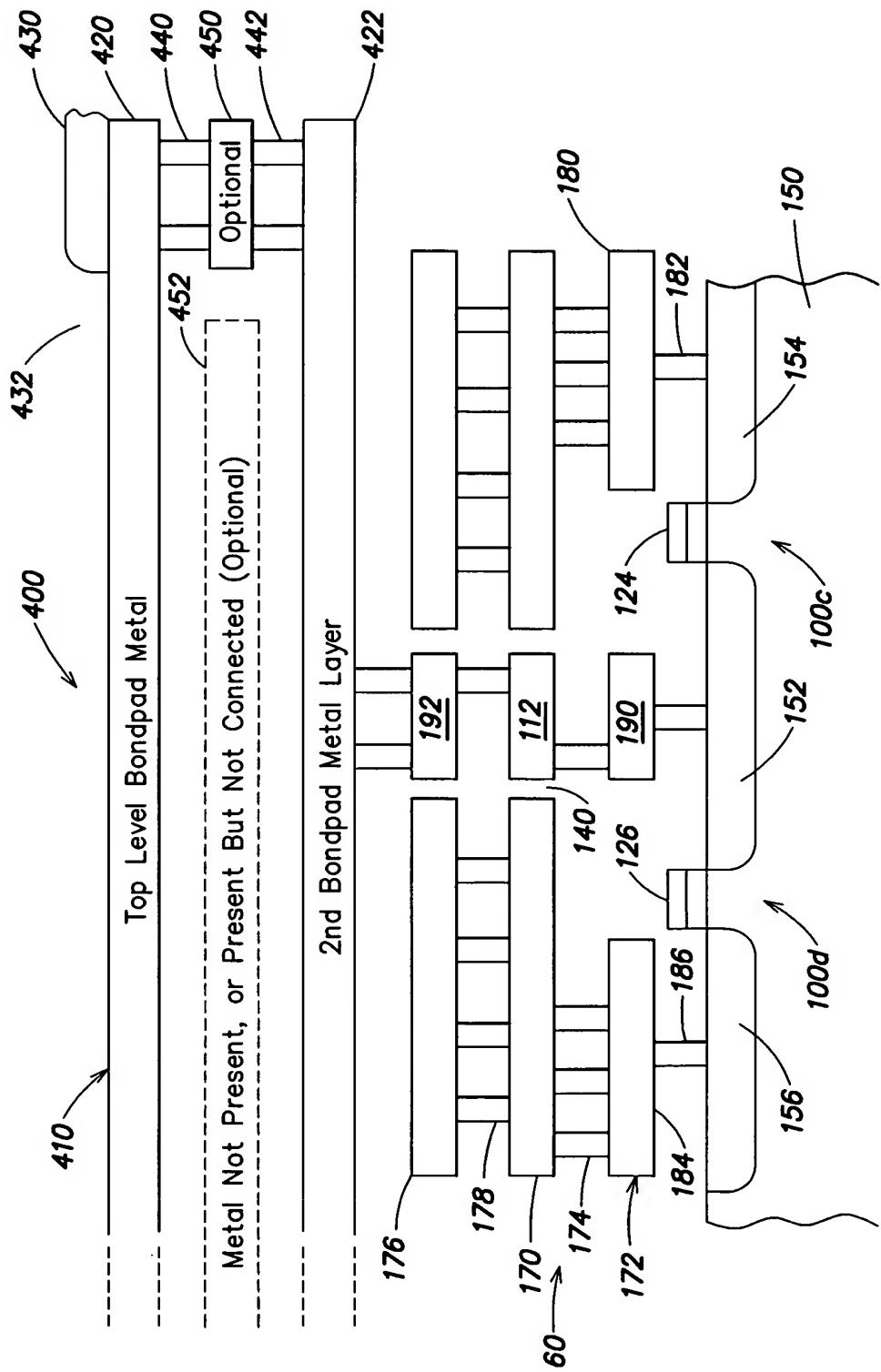


FIG. 11